

SUD50N04-06H

Vishay Siliconix

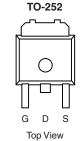
N-Channel 40-V (D-S), 175 °C MOSFET

PRODUCT SUMMARY					
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A) ^c	Q _g (Typ)		
40	0.006 at V _{GS} = 10 V	109	95		

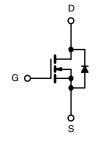
FEATURES

- TrenchFET[®] Power MOSFETS
- 175 °C Junction Temperature
- High Threshold Voltage At High Temperature





Drain Connected to Tab



Ordering Information: SUD50N04-06H-E3 (Lead (Pb)-free)

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_A	= 25 °C, unless othe	rwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	40	v	
Gate-Source Voltage		V _{GS}	± 20		
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C	1_	109 ^c		
	T _C = 100 °C	I _D	77 ^c	А	
Pulsed Drain Current		I _{DM}	100	A	
Avalanche Current (Single Pulse)		I _{AS}	50		
Repetitive Avalanche Energy (Single Pulse) ^a	L = 0.1 mH	E _{AS}	125	mJ	
Power Dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$		PD	136	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
	$t \le 10 \text{ sec}$	R _{thJA}	15	18	°C/W
Junction-to-Ambient ^b	Steady State		40	50	
Junction-to-Case		R _{thJC}	0.85	1.1	

Notes:

a. Duty cycle \leq 1 %.

b. Surface Mounted on 1" FR4 board.

c. Based on maximum allowable Junction Temperature. Package limitation current is 50 A.

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Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	40			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	3.4		5.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1		
	I _{DSS}	V_{DS} = 40 V, V_{GS} = 0 V, T_{J} = 125 °C			50	μA	
		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$			150		
On-State Drain Current ^a	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	50			А	
Drain-Source On-State Resistance ^a		V _{GS} = 10 V, I _D = 20 A		0.0049	0.006		
	r _{DS(on)}	V_{GS} = 10 V, I_{D} = 20 A, T_{J} = 125 °C			0.009	Ω	
		V_{GS} = 10 V, I_{D} = 20 A, T_{J} = 175 °C			0.012		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A	20	50		S	
Dynamic ^b	1						
Input Capacitance	C _{iss}			6700		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$, $V_{DS} = 25 V$, f = 1 MHz		600			
Reversen Transfer Capacitance	C _{rss}			320			
Total Gate Charge ^c	Qg			95		nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 50 \text{ A}$		37			
Gate-Drain Charge ^c	Q _{gd}			21			
Gate Resistance	Rg	f = 1.0 MHz		1.7		Ω	
Turn-On Delay Time ^c	t _{d(on)}			20	30	 I	
Rise Time ^c	t _r	V_{DD} = 20 V, R _L = 0.4 Ω I _D \cong 50 A, V _{GEN} = 10 V, R _g = 2.5 Ω		95	145	ns	
Turn-Off Delay Time ^c	t _{d(off)}			50	75		
Fall Time ^c	t _f			12	20		
Source-Drain Diode Ratings and Cha	racteristics	(T _C = 25 °C) ^b		1			
Continuous Current	ا _S				50		
Pulsed Current	I _{SM}				100	A	
Forward Voltage ^a	V _{SD}	$I_{F} = 30 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		0.90	1.50	V	
Reverse Recovery Time	t _{rr}	I _F = 30 A, di/dt = 100 A/μs		40	60	ns	

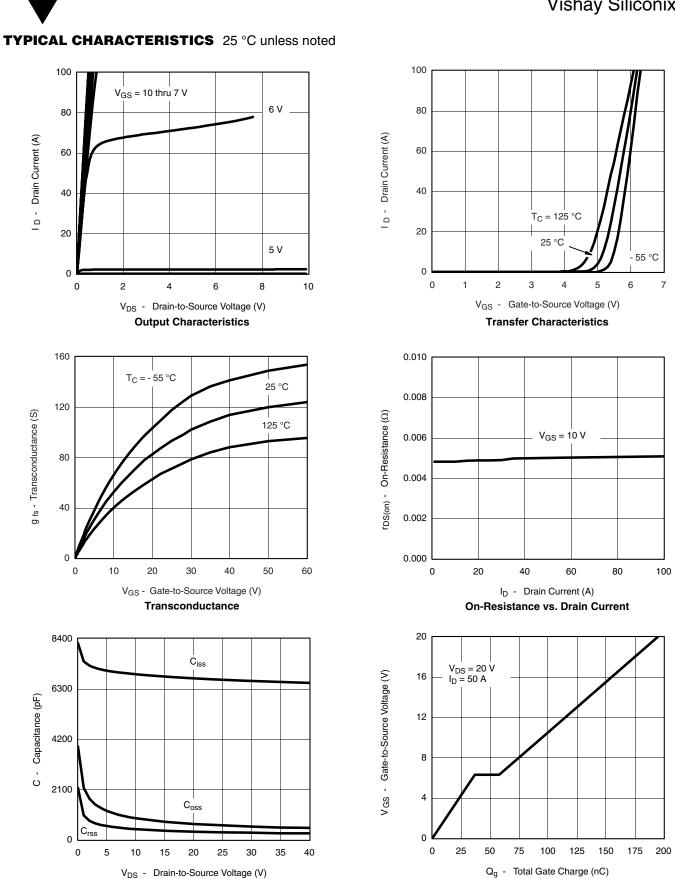
Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



 V_{DS} -

Capacitance

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Document Number: 72860 S-71661-Rev. C, 06-Aug-07 Gate Charge

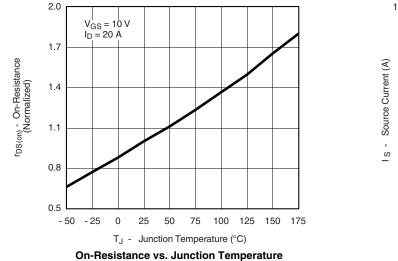
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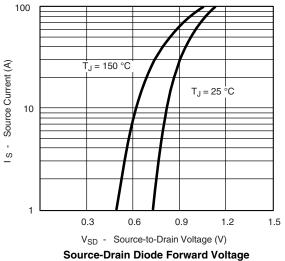
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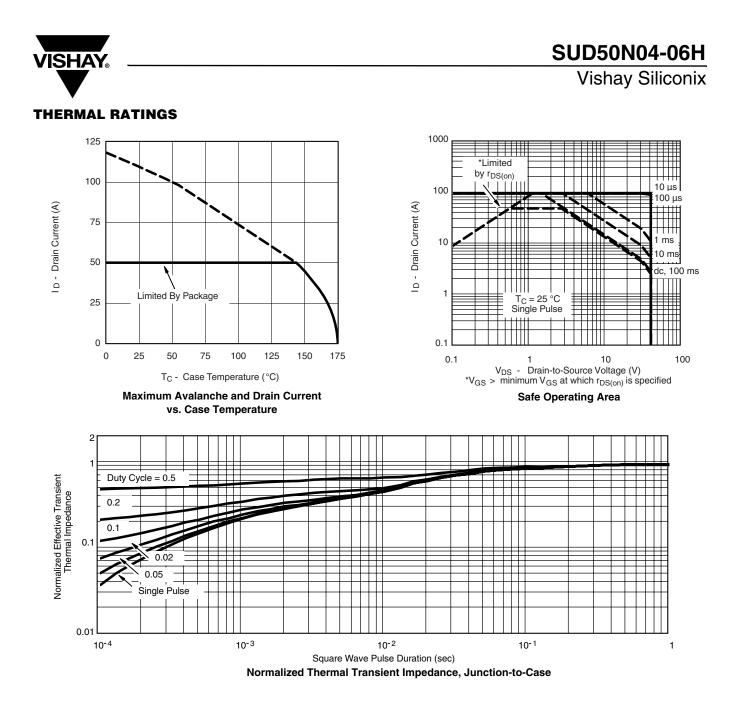
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TYPICAL CHARACTERISTICS 25 °C unless noted







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